



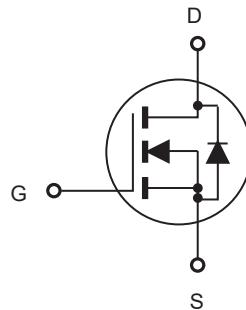
# CEP6040SL/CEB6040SL

## N-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

### FEATURES

- 60V, 116A,  $R_{DS(ON)} = 4.6\text{m}\Omega$  @ $V_{GS} = 10\text{V}$   
 $R_{DS(ON)} = 7.7\text{m}\Omega$  @ $V_{GS} = 4.5\text{V}$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- RoHS compliant.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous@ $T_C = 25^\circ\text{C}$ @ $T_C = 100^\circ\text{C}$	$I_D$	116 82	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM}$	464	A
Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$ - Derate above $25^\circ\text{C}$	$P_D$	100 0.67	W W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy <sup>d</sup>	$E_{AS}$	250	mJ
Single Pulsed Avalanche Current <sup>d</sup>	$I_{AS}$	10	A
Operating and Store Temperature Range	$T_J, T_{stg}$	-55 to 175	$^\circ\text{C}$

### Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\text{JC}}$	1.5	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{\text{JA}}$	62.5	$^\circ\text{C/W}$

This is preliminary information on a new product in development now.  
Details are subject to change without notice.

Rev 1. 2021.May  
<http://www.cet-mos.com>



# CEP6040SL/CEB6040SL

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	60			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$		1		$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	1		3	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$		3.8	4.6	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 20\text{A}$		5.9	7.7	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		1790		pF
Output Capacitance	$C_{\text{oss}}$			725		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			15		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 25\Omega$		22		ns
Turn-On Rise Time	$t_r$			28		ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$			143		ns
Turn-Off Fall Time	$t_f$			90		ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 30\text{V}, I_D = 20\text{A}, V_{\text{GS}} = 4.5\text{V}$		26		nC
Gate-Source Charge	$Q_{\text{gs}}$			4		nC
Gate-Drain Charge	$Q_{\text{gd}}$			15		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				83	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 20\text{A}$			1.2	V

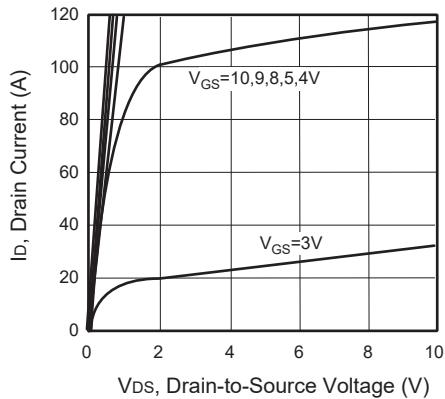
Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature

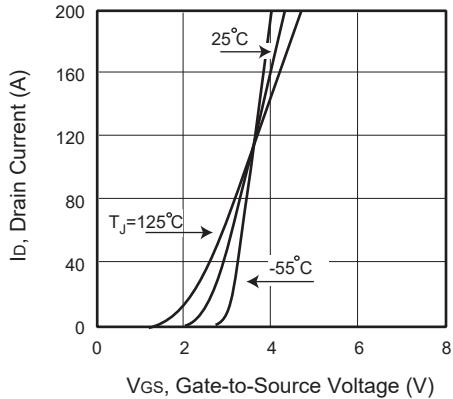
b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle < 2%.

c.Guaranteed by design, not subject to production testing.

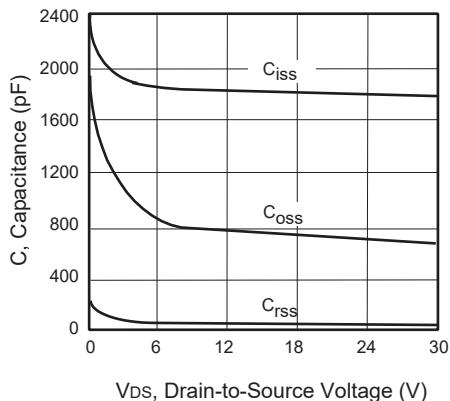
d.L = 5mH,  $I_{AS} = 10\text{A}, V_{DD} = 24\text{V}, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$



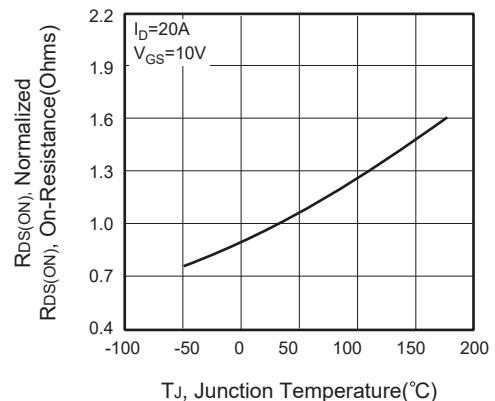
**Figure 1. Output Characteristics**



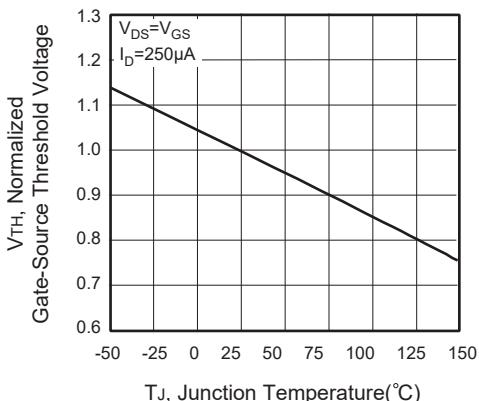
**Figure 2. Transfer Characteristics**



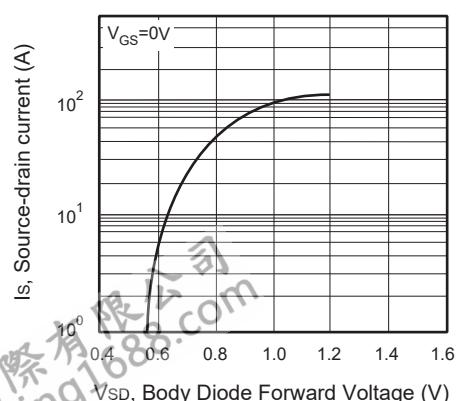
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**



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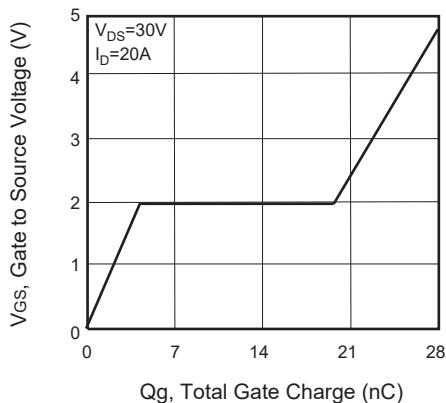


Figure 7. Gate Charge

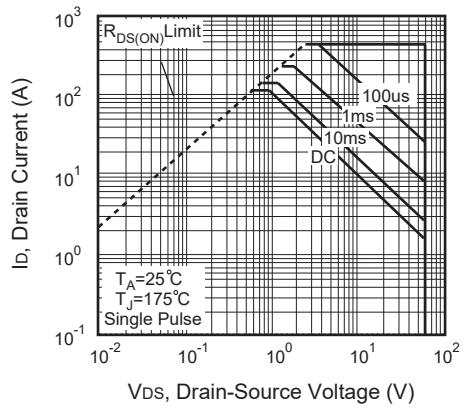


Figure 8. Maximum Safe Operating Area

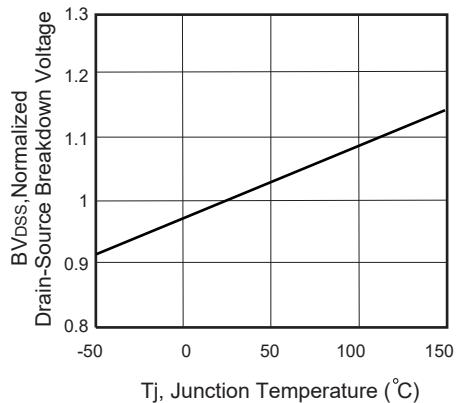


Figure 9. Breakdown Voltage Variation VS Temperature

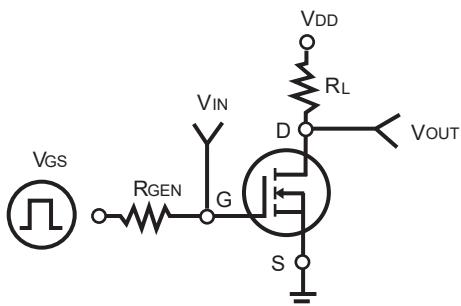


Figure 10. Switching Test Circuit

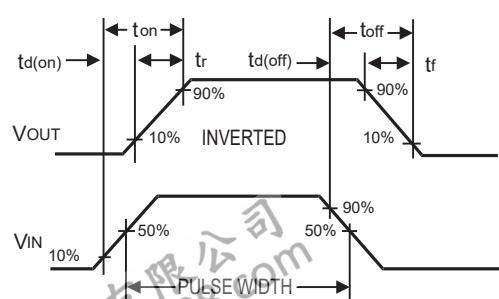


Figure 11. Switching Waveforms



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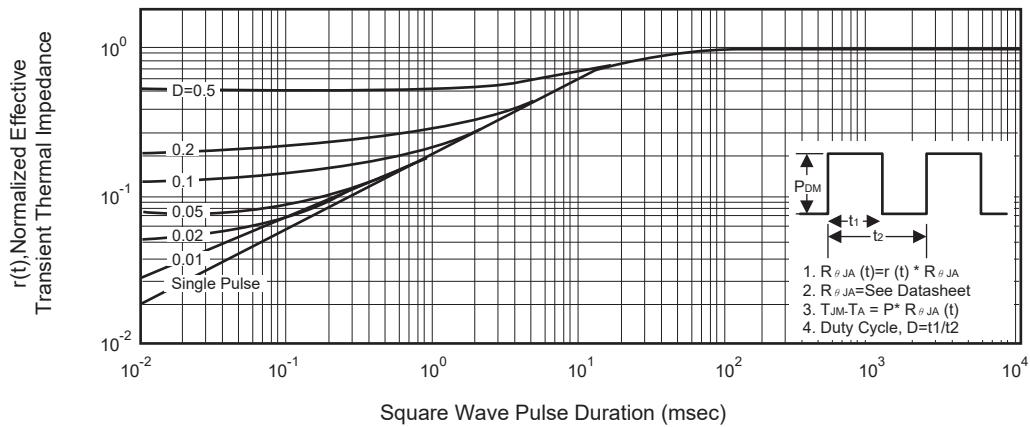


Figure 12. Normalized Thermal Transient Impedance Curve